Tyrone Camarero Specifications



Camarero DS3007R-28R

Key features

- Dual socket R3 (LGA 2011) supports Intel® Xeon® processor E5-2600 v4/ v3 family
- Intel® C612 chipset
- Up to 2TB ECC 3DS LRDIMM, up to DDR4- 2400MHz; 16x DIMM slots
- 1x PCI-E 3.0 x16,6x PCI-E 3.0 x8
- Intel® i350 Dual port GbE LAN
- 10x SATA3 (6Gbps) ports w/ Intel C612 controller; RAID 0, 1, 5, 10
- 8x SAS3 (12Gbps) ports w/ LSI 3108 controller (2GB cache); RAID 0, 1, 5, 6, 10, 50, 60
- Integrated IPMI 2.0 and KVM with Dedicated LAN
- 5x USB 3.0 and 4x USB 2.0 ports
- 8 x 3.5" hot-swap SAS/SATA drive bay with SGPIO, 2 x 3.5" fixed drive bay
- 8-port 2U SAS3 12Gbps TQ backplane, support up to 8x 3.5-inch SAS3/SATA3 HDD/SSD
- 7 low-profile expansion slot(s)
- 740W Redundant Platinum Power Supply W/PMbus





Processor/Cache

Processor Dual socket R3 (LGA 2011) supports

Intel® Xeon® processor E5-2600 v4/ v3 family

Chipset

Chipset Intel® C612 chipset

System Memory

Memory Capacity Up to 2TB ECC 3DS LRDIMM,

up to DDR4- 2400MHz; 16x DIMM slots

Expansion Slots

PCI-Express 1x PCI-E 3.0 x16,6x PCI-E 3.0 x8

Integrated On-Board

SAS LSI 3108 SAS3 (12Gbps) controller;

HW RAID 0, 1, 5, 6, 10, 50, 60

SATA SATA3 (6Gbps); RAID 0, 1, 5, 10 LAN 2x RJ45 Gigabit Ethernet LAN ports,

1x RJ45 Dedicated IPMI LAN port

Add-on Options

Optical Drive Optional

Front Panel

LED 2 Network Activity LEDs, HDD activity LED,

Power Status LED, Power Fail LED,

System Information LED

Buttons Power On/Off button ,System Reset button

Drive Bays

Hotswap 8 x 3.5" hot-swap SAS/SATA drive bay with

SGPIO, 2 x3.5" fixed drive bay

Peripheral Drives 1 x slim DVD-ROM drive bay

Power Supply

740W Redundant Platinum Power Supply W/PMbus

Cooling System

3 x 8cm (7000 RPM) hot-swap PWM cooling fan(s)

Form Factor

Form Factor 2U Rackmount

 Height
 :
 3.5" (89 mm),

 Width
 :
 17.2" (437 mm),

 Depth
 :
 25.5" (647 mm)

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For more/current product information, visit www.tyronesystems.com

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